Contents TDA7387

Contents

1	Bloc	k and pin connection diagrams 5
2	Elec	trical specifications 6
	2.1	Absolute maximum ratings 6
	2.2	Thermal data 6
	2.3	Electrical characteristics
	2.4	PCB and component layout 8
	2.5	Electrical characteristics curves
3	Арр	lication hints
	3.1	Biasing and SVR
	3.2	Input stage 10
	3.3	Standby and muting11
	3.4	Stability and layout considerations
4	Pacl	kage information
5	Revi	sion history14

TDA7387 List of tables

List of tables

	Device summary	
Table 2.	Absolute maximum ratings	6
Table 3.	Thermal data	6
Table 4.	Electrical characteristics	6
Table 5.	Document revision history	4

List of figures TDA7387

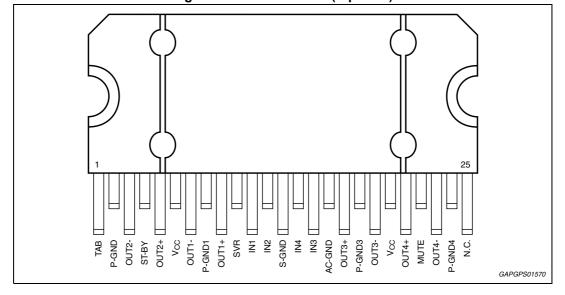
List of figures

Figure 1.	Block diagram	5
Figure 2.	Pin connection (top view)	5
Figure 3.	Standard test and application circuit	
Figure 4.	Components and top copper layer	8
Figure 5.	Bottom copper layer	8
Figure 6.	Quiescent current vs. supply voltage	9
Figure 7.	Quiescent output voltage vs. supply voltage	9
Figure 8.	Output power vs. supply voltage (4 Ω)	9
Figure 9.	Distortion vs. output power	9
Figure 10.	Distortion vs. frequency	9
Figure 11.	Power dissipation and efficiency vs. output power	9
Figure 12.	Input/output biasing	. 10
Figure 13.	Flexiwatt25 mechanical data and package dimensions	. 12
Figure 14	Flexiwatt25 mechanical data and package dimensions	13

Block and pin connection diagrams

Figure 1. Block diagram Vcc1 100nF ST-BY N.C. MUTE OUT1+ IN1 o-OUT1-0.1μF PW-GND OUT2+ OUT2-IN2 o-0.1μF PW-GND OUT3+ IN3 o OUT3-0.1μF PW-GND OUT4+ \dashv OUT4-0.1μF PW-GND AC-GND TAB S-GND 47μF $0.1 \mu F$ GAPGPS01569

Figure 2. Pin connection (top view)



2 Electrical specifications

2.1 Absolute maximum ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _S	Operating supply voltage	18	V
V _{S (DC)}	DC supply voltage	28	V
V _{S (pk)}	Peak supply voltage (t = 50 ms)	50	V
I _O	Output peak current: Repetitive (duty cycle 10 % at f = 10 Hz) Non repetitive (t = 100 µs)	4.5 5.5	A A
P _{tot}	Power dissipation, (T _{case} = 70 °C)	80	W
T _j	Junction temperature	150	°C
T _{stg}	Storage temperature	– 55 to 150	°C

2.2 Thermal data

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{th j-case}	Thermal resistance junction-to-case max. TDA7387 TDA7387EP/EPAG	1 1.3	°C/W
T _{amb}	Operative temperature range TDA7387EP	-30 to +85	°C
	Operative temperature range TDA7387,TDA7387EPAG	-40 to +105	°C

2.3 Electrical characteristics

 V_S = 14.4 V; f = 1 kHz; R_g = 600 Ω ; R_L = 4 Ω ; T_{amb} = 25 °C; Refer to the test and application diagram (*Figure 3*), unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
I _{q1}	Quiescent current	-	-	180	300	mA
V _{OS}	Output offset voltage	-	-	-	100	mV
G _v	Voltage gain	-	25	26	27	dB
Po	Output power	THD = 10% THD = 1%	20 -	22 18	1	W

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit	
В	Max. output power ⁽¹⁾	V _S = 14.4 V	33	37	-	۱۸/	
P _{o max.}	wax. output power V	V _S = 15.2 V	-	41	-	W	
THD	Distortion	P ₀ = 4 W	-	0.04	0.3	%	
e _{No}	Output noise	"A" Weighted; Bw = 20 Hz to 20 kHz	-	50 65	150	μV μV	
SVR	Supply voltage rejection	f = 100 Hz	50	65	-	dB	
f _{cl}	Low cut-off frequency	-	-	20	-	Hz	
f _{ch}	High cut-off frequency	-	75		-	kHz	
R _i	Input impedance	-	70	100	-	kΩ	
C _T	Cross talk	f = 1 kHz	50	70	-	dB	
I _{SB}	Standby current consumption	V _{standby} = 0 V	-	-	15	μA	
V _{SB out}	Standby out threshold voltage	(Amp: on)	3.5	-	-	V	
V _{SB IN}	Standby in threshold voltage	(Amp: off)	-	-	1.5	V	
A _M	Mute attenuation	V _O = 1Vrms	80	90	-	dB	
V _{M out}	Mute out threshold voltage	(Amp: play)	3.5	-	-	V	
V _{M in}	Mute in threshold voltage	(Amp: mute)	-	-	1.5	V	
I _{m (L)}	Muting pin current	V _{MUTE} = 1.5 V (source current)	5	10	16	μΑ	

^{1.} Saturated square wave output.

Figure 3. Standard test and application circuit C7 _____ 0.1μF 2200μF Vcc1-2 Vcc3-4 1μF R2 MUTE C 47K C10 5 C1 ╫ 0.1μF \dashv 17 C2 0.1µF 18 OUT3 19 ╢ IN3 15 C3 0.1µF 21 \leftarrow 24 $C4\ 0.1 \mu F$ S-GND 23 TAB GAPGPS01571

2.4 PCB and component layout

Refer to Figure 3: Standard test and application circuit.

Figure 4. Components and top copper layer

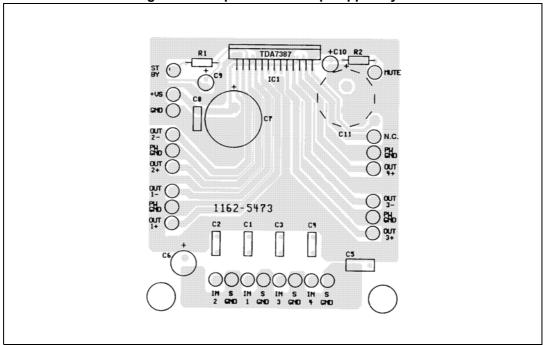
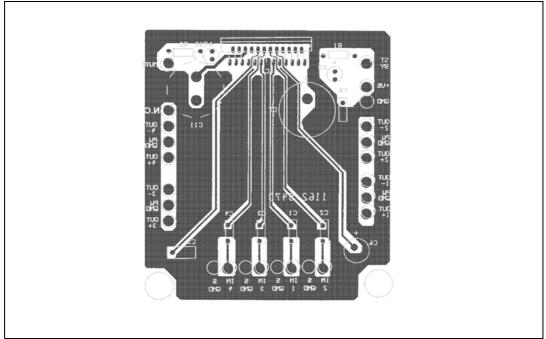
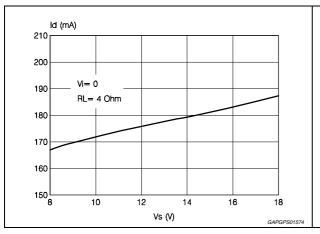


Figure 5. Bottom copper layer



2.5 Electrical characteristics curves

Figure 6. Quiescent current vs. supply voltage Figure 7. Quiescent output voltage vs. supply voltage



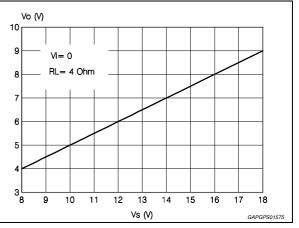
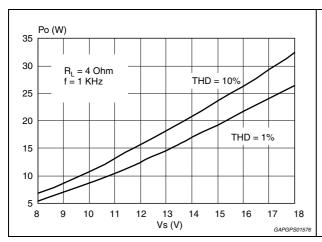


Figure 8. Output power vs. supply voltage (4 Ω)

Figure 9. Distortion vs. output power



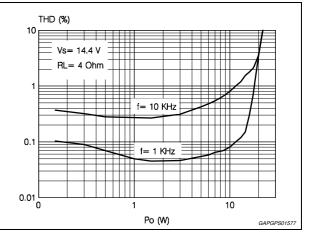
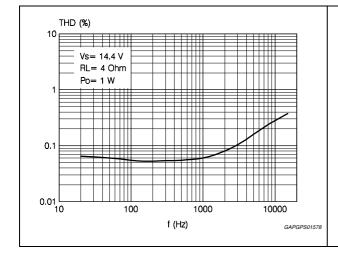
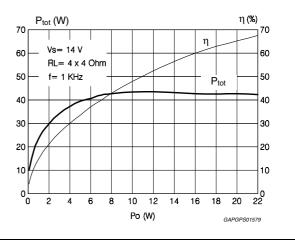


Figure 10. Distortion vs. frequency

Figure 11. Power dissipation and efficiency vs. output power





47/

Application hints TDA7387

3 Application hints

Refer to Figure 3.

3.1 Biasing and SVR

As shown in *Figure 12*, all the TDA7387's main sections, such as Inputs, Outputs AND ACGND (pin 16) are internally biased at half supply voltage level (Vs/2), coming from the Supply Voltage Rejection (SVR) block. In this way no current flows through the internal feedback network. The AC-GND is common to all the 4 amplifiers and represents the connection point of all the inverting inputs.

Both individual inputs and AC-GND are connected to Vs/2 (SVR) by means of 100 k Ω resistors.

To ensure proper operation and high supply voltage rejection, it is of fundamental importance to provide a good impedance matching between Inputs and AC-GROUND terminations. This implies that \mathbf{C}_1 , \mathbf{C}_2 , \mathbf{C}_3 , \mathbf{C}_4 , \mathbf{C}_5 capacitors have to carry the same nominal value and their tolerance should never exceed \pm 10 %.

Besides its contribution to the ripple rejection, the SVR capacitor controls the turn ON/OFF time sequence and, consequently, plays an essential role in the pop optimization during ON/OFF transients. To conveniently serve both needs, **its minimum recommended value is 10\mu F**.

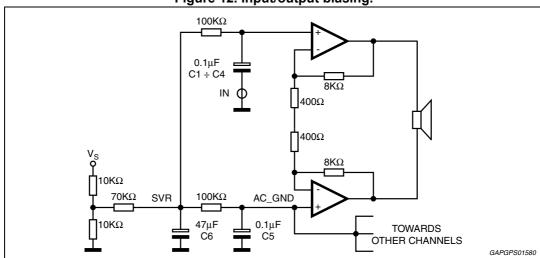


Figure 12. Input/output biasing.

3.2 Input stage

The TDA7387's inputs are ground-compatible and can stand very high input signals (± 8 Vpk) without any performances degradation.

If the standard value for the input capacitors (0.1 μ F) is adopted, the low frequency cut-off turns out to be 16 Hz.

TDA7387 Application hints

3.3 Standby and muting

Standby and muting facilities are both CMOS-compatible. If unused, a straight connection to Vs of their respective pins would be admissible. Conventional low-power transistors can be used to drive muting and stand-by pins in absence of true CMOS ports or microprocessors. R-C cells have always to be used in order to smooth down the transitions for preventing any audible transient noises.

Since a DC current of about 10 μ A normally flows out of pin 22, the maximum allowable muting-series resistance (R₂) is 70 k Ω , which is sufficiently high to allow a muting capacitor reasonably small (about 1 μ F).

If R_2 is higher than recommended, the involved risk is that the voltage at pin 22 may rise to above the 1.5 V threshold voltage and the device is consequently fails to turn OFF when the mute line is brought down.

About the stand-by, the time constant to be assigned in order to obtain a virtually pop-free transition has to be slower than 2.5 V/ms.

3.4 Stability and layout considerations

If properly layouted and hooked to standard car-radio speakers, the TDA7387 is intrinsically stable with no need of external compensations such as output R-C cells. Due to the high number of channels involved, this translates into a very remarkable components saving if compared to similar devices on the market.

To simplify pc-board layout design, each amplifier stage has its own power ground externally accessible (pins 2,8,18,24) and one supply voltage pin for each couple of them. Even more important, this makes it possible to achieve the highest possible degree of separation among the channels, with remarkable benefits in terms of cross-talk and distortion features.

About the layout grounding, it is particularly important to connect the AC-GND capacitor (C_5) to the signal GND, as close as possible to the audio inputs ground: this guarantees high rejection of any common mode spurious signal.

The SVR capacitor (C_6) has also to be connected to the signal GND.

Supply filtering elements (C_7, C_8) have naturally to be connected to the power-ground and located as close as possible to the Vs pins.

Pin 1, which is mechanically attached to the device's tab, needs to be tied to the cleanest power ground point in the pc-board, which is generally near the supply filtering capacitors.

The exposed pad package doesn't require any particular care compared to the ST standard flexiwatt package. For particular PCB configurations, in order to maximize the rejection against any disturbances coming from the battery line (SVR), it is suggested to use one of the following IC metal slug (heat-sink) connections:

- leave the slug simply electrically isolated from the PCB ground;
- in case of 2 layers board, connect the slug to the PCB power ground (P-GND) and not to the signal ground (S-GND);
- in case of a PCB with a layer dedicated to grounding (wide / diffused GND area with no distinction between P-GND and S-GND) connect the slug to the common board ground.

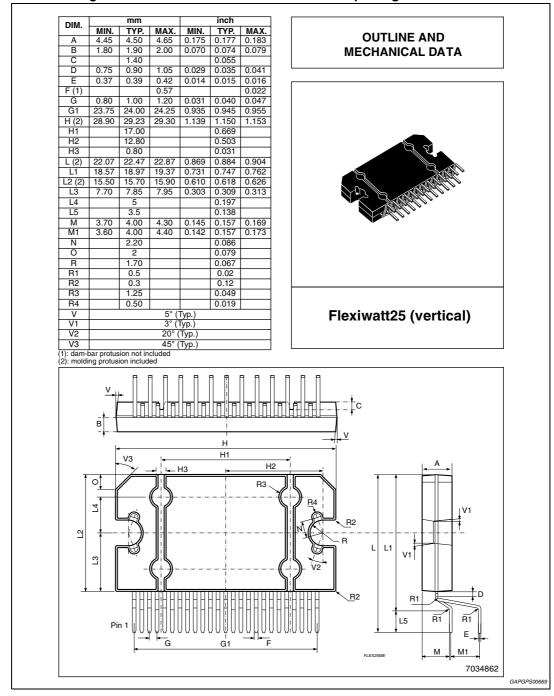
Package information TDA7387

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com.

ECOPACK® is an ST trademark.

Figure 13. Flexiwatt25 mechanical data and package dimensions



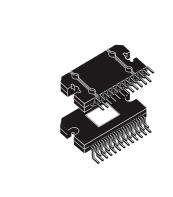
Ay/

TDA7387 Package information

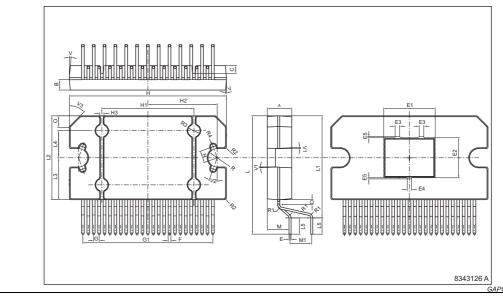
Figure 14. Flexiwatt25 mechanical data and package dimensions

DIM.		mm			inch			
Diril.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
Α	4.450	4.500	4.650	0.1752	0.1772	0.183		
В	1.800	1.900	2.000	0.0709	0.0748	0.078		
С		1.400			0.0551			
D	0.750	0.900	1.050	0.0295	0.0354	0.041		
E	0.370	0.390	0.420	0.0146	0.0154	0.016		
E1	9.480	9.500	9.530	0.3732	0.3740	0.375		
E2	7.380	7.400	7.430	0.2906	0.2913	0.292		
E3	0.850			0.0335				
E4	0.500			0.0197				
E5			0.200			0.007		
F (*)			0.570			0.022		
G	0.800	1.000	1.200	0.0315	0.0394	0.047		
G1	23.750	24.000	24.250	0.9350	0.9449	0.954		
H (**)	28.900	29.230	29.300	1.1378	1.1508	1.153		
H1		17.000			0.6693			
H2		12.800			0.5039			
НЗ		0.800			0.0315			
L (**)	22.070	22.470	22.870	0.8689	0.8846	0.900		
L1	18.570	18.970	19.370	0.7311	0.7469	0.762		
L2 (**)	15.500	15.700	15.900	0.6102	0.6181	0.626		
L3	7.700	7.850	7.950	0.3031	0.3091	0.313		
L4		5.000			0.1969			
L5		3.500			0.1378			
M	3.700	4.000	4.300	0.1457	0.1575	0.169		
M1	3.600	4.000	4.400	0.1417	0.1575	0.173		
N		2.200			0.0866			
0		2.000			0.0787			
R		1.700			0.0669			
R1		0.500			0.0197			
R2		0.300			0.0118			
R3		1.250			0.0492			
R4		0.500			0.0197			
V5			5 ° (Тур.)				
V1			3°(Тур.)				
V2	20 ° (Typ.)							
V3				(Typ.)				
	ion "F" dom	has asstrai	on not inclu	dod				

OUTLINE AND MECHANICAL DATA



Flexiwatt25 Vertical (Exposed pad)



Revision history TDA7387

5 Revision history

Table 5. Document revision history

Date	Revision	Changes	
09-Apr-2013	1	Initial release.	
18-Sep-2013	2	Updated Disclaimer.	

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics:

TDA7387 TDA7387EP TDA7387EPAG